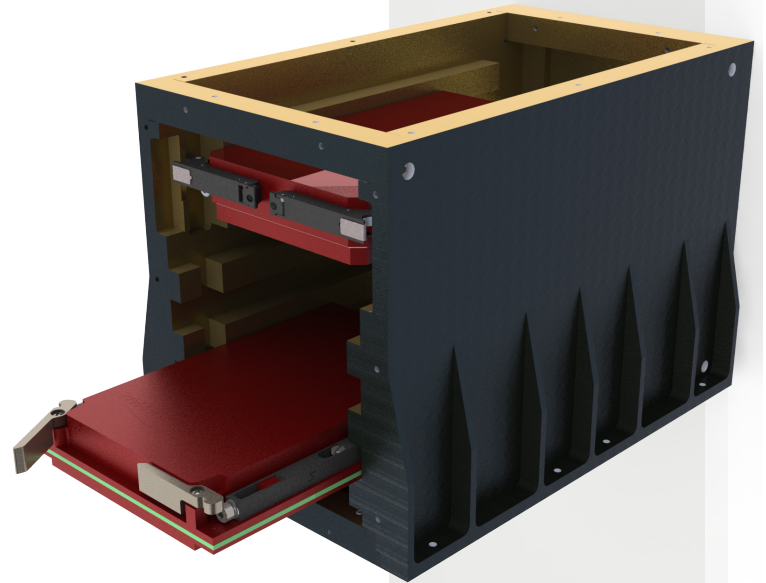


# CCC-3S-3U CONDUCTION COOLED CHASSIS DATA SHEET



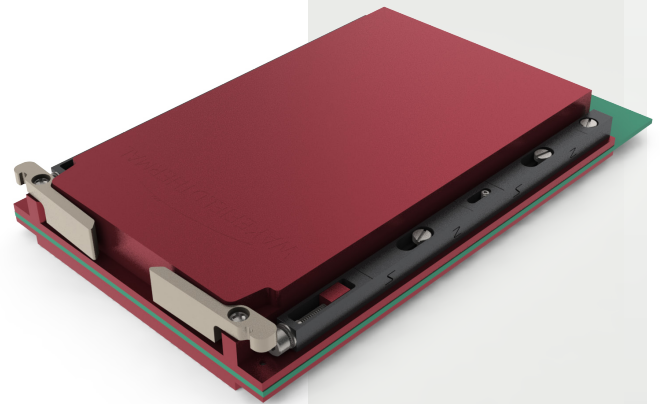
Wakefield Thermal's VPX 3U Conduction Cooled Chassis are used in various harsh rugged and defense applications. These applications include shipborne, airborne, and ground mission critical equipment.

The VPX 3U Conduction Cooled Chassis are designed to meet VITA 48.2 standards and integrate respective components, such as heat frames, seamlessly.

Utilizing plug in boards, the conduction cooled heat frame transfers the heat from the components to the chassis flows through heatsinks in the chassis, to provide optimal cooling of the electronic devices. The chassis holds up to three 3U plug in boards and can accept a backplane and power supply for testing purposes.

## FEATURES

- Designed for use in VITA 48.2 applications
- Holds up to 3 VPX 3U cards
- Heatframe sold separately. See data sheet VPX-482085-3U





**COOLVATION**  
Innovative Thermal Solutions

# 5 STEP THERMAL ENGINEERING GUIDE From Concept To Cooling

COOLVATION provides thermal management engineering services to improve products' thermal performance while applying cost effective solutions to eliminate unnecessary manufacturing costs. COOLVATION is a seamless resource extension for our customers' thermal & mechanical engineering teams from ideation to lab testing.



## Customer Thermal Challenge

- Physical limitations
- Power constraints
- Air flow/ fluid conditions
- Environmental conditions
- Component specifications
- Define ideal state

01  
STEP



## Execution

- Concept analysis (CFD-ansys/ ice pack, fin optimizations software)
- Solid model
- Analysis & verification
- Cost analysis

03  
STEP



## Global Manufacturing

- Global manufacturing facilities
- Global warehousing
- Global labs to support future program

05  
STEP



## Collaboration

- Review conditions
- Statement of work to customer
- Historical consideration along with cutting edge technologies to provide cost effective solution

02  
STEP



## Solution & Verification

- Dedicated new product development center
- Prototype
- Physical thermal lab testing
- Proven manufacturability

04  
STEP

